

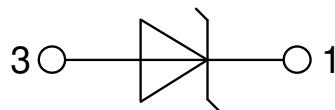
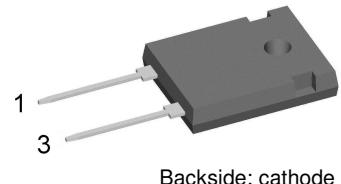
Schottky Diode

V_{RRM} = 45 V
 I_{FAV} = 60 A
 V_F = 0.57 V

High Performance Schottky Diode
 Low Loss and Soft Recovery
 Single Diode

Part number

DSS60-0045B



Features / Advantages:

- Very low V_F
- Extremely low switching losses
- Low I_{rm} values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package: TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Disclaimer Notice

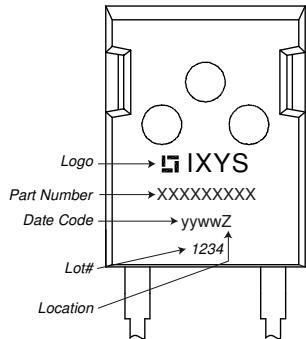
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Schottky

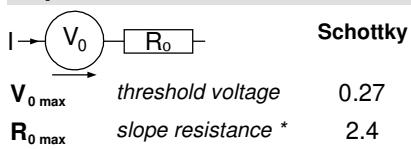
| Symbol | Definition | Conditions | Ratings | | | |
|-------------------|--|--|---|------|------------------------------|---------|
| | | | min. | typ. | max. | |
| V_{RSM} | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^\circ C$ | | | 45 | V |
| V_{RRM} | max. repetitive reverse blocking voltage | $T_{VJ} = 25^\circ C$ | | | 45 | V |
| I_R | reverse current, drain current | $V_R = 45 V$ $V_R = 45 V$ | $T_{VJ} = 25^\circ C$ $T_{VJ} = 100^\circ C$ | | 60 250 | mA |
| V_F | forward voltage drop | $I_F = 60 A$ $I_F = 120 A$ $I_F = 60 A$ $I_F = 120 A$ | $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$ | | 0.60 0.86 0.57 0.87 | V |
| I_{FAV} | average forward current | $T_C = 105^\circ C$ rectangular $d = 0.5$ | $T_{VJ} = 150^\circ C$ | | 60 | A |
| V_{F0} r_F | threshold voltage slope resistance } for power loss calculation only | | $T_{VJ} = 150^\circ C$ | | 0.27 4.9 | V mΩ |
| R_{thJC} | thermal resistance junction to case | | | | 0.8 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | | 0.25 | | K/W |
| P_{tot} | total power dissipation | | $T_C = 25^\circ C$ | | 155 | W |
| I_{FSM} | max. forward surge current | $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$ | $T_{VJ} = 45^\circ C$ | | 600 | A |
| C_J | junction capacitance | $V_R = 5 V$ $f = 1 \text{ MHz}$ | $T_{VJ} = 25^\circ C$ | | 2.93 | nF |
| E_{AS} | non-repetitive avalanche energy | $I_{AS} = 31 A$ $L = 180 \mu H$ | $T_{VJ} = 25^\circ C$ | | 137 | mJ |
| I_{AR} | repetitive avalanche current | $V_A = 1.5 \cdot V_R$ typ. $f = 10 \text{ kHz}$ | | | 3.1 | A |

Package TO-247

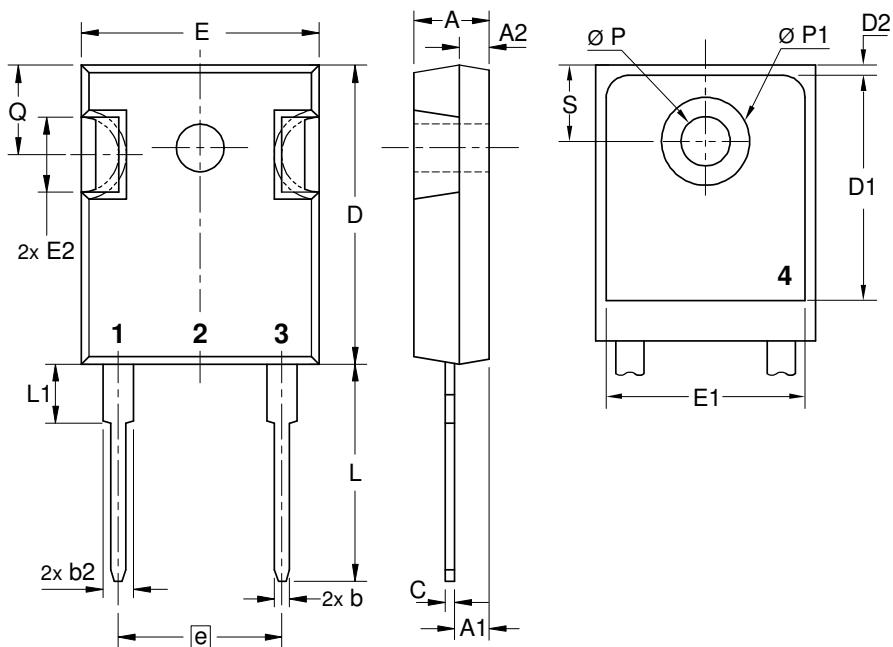
| Symbol | Definition | Conditions | min. | typ. | max. | Unit |
|---------------|-------------------------------------|--------------|------|------|------|------|
| I_{RMS} | <i>RMS current</i> | per terminal | | | 70 | A |
| T_{VJ} | <i>virtual junction temperature</i> | | -55 | | 150 | °C |
| T_{op} | <i>operation temperature</i> | | -55 | | 125 | °C |
| T_{stg} | <i>storage temperature</i> | | -55 | | 150 | °C |
| Weight | | | | 6 | | g |
| M_d | <i>mounting torque</i> | | 0.8 | | 1.2 | Nm |
| F_c | <i>mounting force with clip</i> | | 20 | | 120 | N |

Product Marking


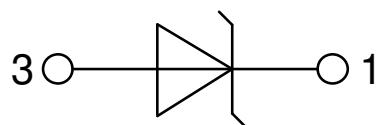
| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | DSS60-0045B | DSS60-0045B | Tube | 30 | 475599 |

Equivalent Circuits for Simulation
* on die level
 $T_{VJ} = 150^\circ\text{C}$


Outlines TO-247



| Sym. | Inches | | Millimeter | |
|------|--------|-------|------------|-------|
| | min. | max. | min. | max. |
| A | 0.185 | 0.209 | 4.70 | 5.30 |
| A1 | 0.087 | 0.102 | 2.21 | 2.59 |
| A2 | 0.059 | 0.098 | 1.50 | 2.49 |
| D | 0.819 | 0.845 | 20.79 | 21.45 |
| E | 0.610 | 0.640 | 15.48 | 16.24 |
| E2 | 0.170 | 0.216 | 4.31 | 5.48 |
| e | 0.430 | BSC | 10.92 | BSC |
| L | 0.780 | 0.800 | 19.80 | 20.30 |
| L1 | - | 0.177 | - | 4.49 |
| Ø P | 0.140 | 0.144 | 3.55 | 3.65 |
| Q | 0.212 | 0.244 | 5.38 | 6.19 |
| S | 0.242 | BSC | 6.14 | BSC |
| b | 0.039 | 0.055 | 0.99 | 1.40 |
| b2 | 0.065 | 0.094 | 1.65 | 2.39 |
| b4 | 0.102 | 0.135 | 2.59 | 3.43 |
| c | 0.015 | 0.035 | 0.38 | 0.89 |
| D1 | 0.515 | - | 13.07 | - |
| D2 | 0.020 | 0.053 | 0.51 | 1.35 |
| E1 | 0.530 | - | 13.45 | - |
| Ø P1 | - | 0.29 | - | 7.39 |



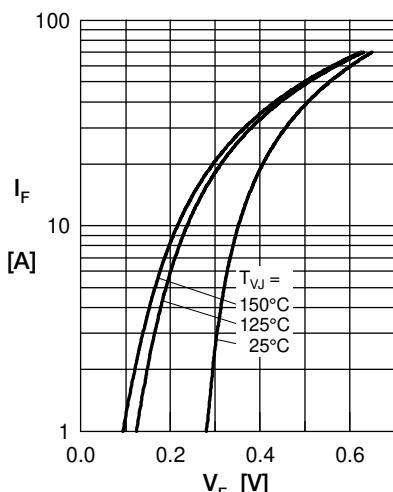
Schottky


Fig. 1 Max. forward voltage drop characteristics

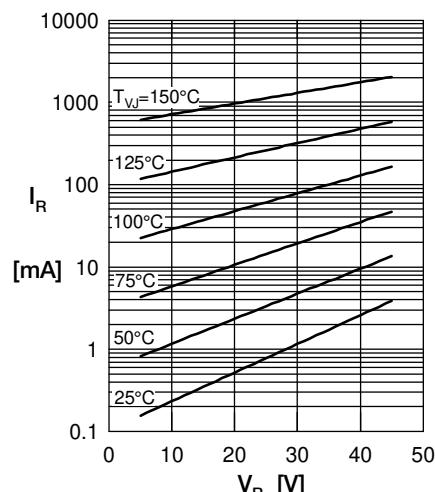


Fig. 2 Typ. reverse current I_R vs. reverse voltage V_R

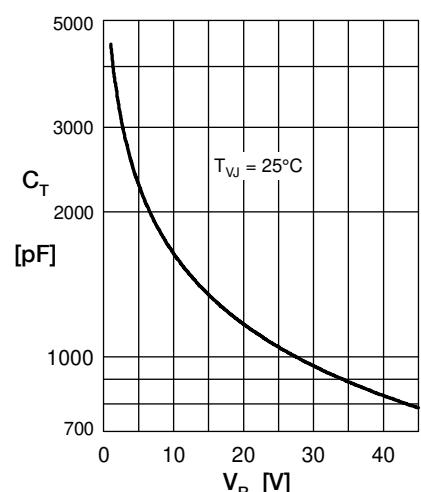


Fig. 3 Typ. junction capacitance C_T vs. reverse voltage V_R

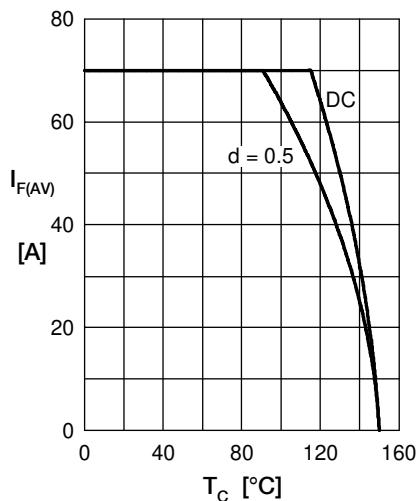


Fig. 4 Average forward current $I_{F(AV)}$ vs. case temp. T_C

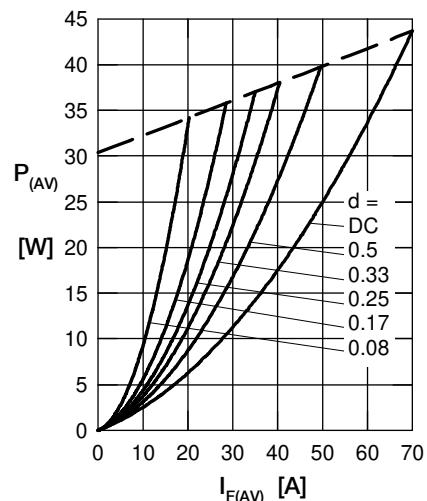


Fig. 5 Forward power loss characteristics

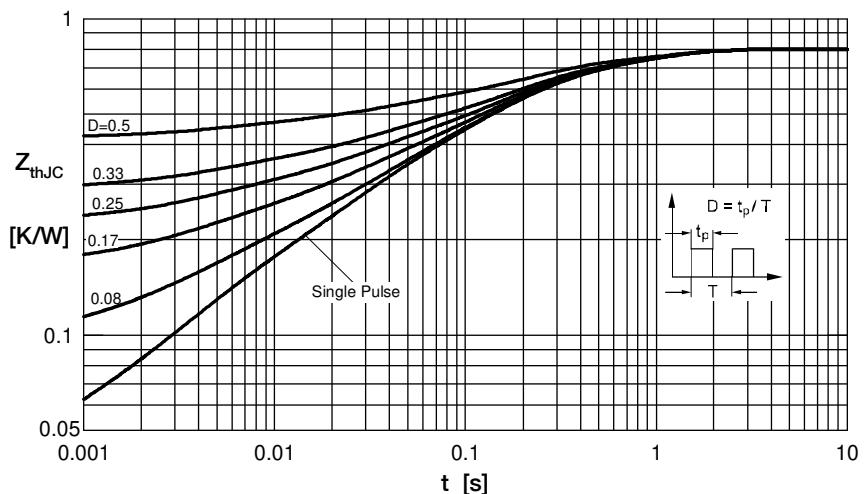


Fig. 6 Transient thermal impedance junction to case at various duty cycles

Note: All curves are per diode